



Spec No.:

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1. Description

SMD LEDs from Lite-On are available in miniature sizes and special configurations for automated PC board assembly and space-sensitive applications. These SMD LEDs are suitable for use in a wide variety of electronic equipment, including cordless and cellular phones, notebook computers, network systems, home appliances, and indoor signboard applications.

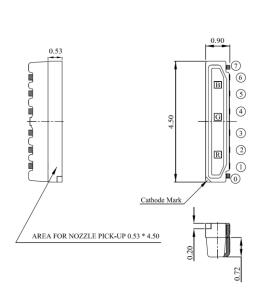
1.1 Features

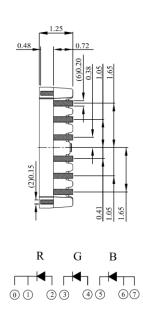
- Meet ROHS
- Package in 12mm tape on 7" diameter reels
- EIA STD package
- I.C. compatible
- Compatible with automatic placement equipment
- Compatible with infrared reflow solder process
- Preconditioning: accelerate to JEDEC level 3

1.2 Applications

- Telecommunication, Office automation, home appliances, industrial equipment
- Signage
- Indoor display

2. Package Dimensions





Part No.	Lens Color	Source Color	Pin Assignment
		AllnGaP Red	1, 2
LTST-008EGBW-LT1	White Diffused	InGaN Green	3, 4
		InGaN Blue	5, 6

Notes:

- 1. All dimensions are in millimeters.
- 2. Tolerance is ±0.2 mm (.008") unless otherwise noted.



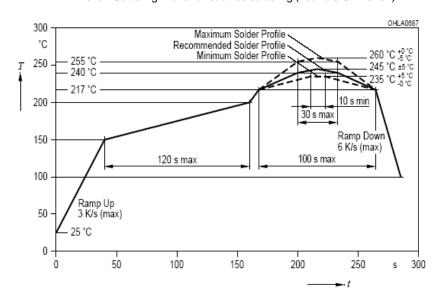
3. Rating and Characteristics

3.1 Absolute Maximum Ratings at Ta=25°C

Description	LTS	I I with		
Parameter Parameter	Red	Green	Blue	Unit
Power Dissipation	72	98	98	mW
Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	80	80	80	mA
DC Forward Current	30	30	30	mA
Operating Temperature Range	-40°C to + 85°C			
Storage Temperature Range	-40°C to + 100°C			

3.2 Suggest IR Reflow Condition for Pb Free Process:

IR-Reflow Soldering Profile for lead free soldering (Acc. to J-STD-020B)





3.3 Electrical / Optical Characteristics at Ta=25°C

Parameter	Symbol		LTS	LTST-008EGBW-LT1			Test	
raranneter	Symbol		Red	Green	Blue	Unit	Condition	
		MIN.	1.07	2.70	0.47		IF = 15mA Note 1	
Luminous Intensity	$\Phi_{ m v}$	TYP.	-	-	-	lm		
		MAX.	2.13	5.35	0.94			
		MIN.	385	970	170	mcd		
Luminous Intensity	IV	TYP.	-	-	-		IF = 15mA Note 2	
		MAX.	770	1930	340			
Viewing Angle	$2\theta_{1/2}$	TYP.		130			Note 3 (Fig.5)	
Peak Emission Wavelength	λΡ	TYP.	631	518	458	nm	Measurement @Peak (Fig.1)	
			619	522	459			
Dominant Wavelength	λd	TYP.	-	-	-	nm	IF = 15mA Note 4	
			628	531	468			
Spectral Line Half-Width	Δλ	TYP.	20	25	35	nm		
		MIN.	1.9	2.75	2.75			
Forward Voltage	VF	TYP.	-	-	-	V	V IF = 15mA Note 5	
		MAX.	2.4	3.25	3.25			
Reverse Current	IR	MAX.	10	10	10	μΑ	VR = 5V Note 6	

Notes:

- Luminous intensity is measured with a light sensor and filter combination that approximates the CIE
 eye-response curve
- 2. Luminous Intensity (mcd) is for reference.
- 3. θ 1/2 is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
- 4. The dominant wavelength, λd is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device
- 5. Forward Voltage Tolerance is +/- 0.1 volt.
- 6. Reverse voltage (VR) condition is applied to IR test only. The device is not designed for reverse operation.



4. Bin Rank

■ IV Rank

Luminous	Intensity	Color : Red	@ 15mA	
Bin Code	Luminous Flux (lm)		Luminous Intensity (mcd)	
Bill Code	Min.	Max.	Min.	Max.
RA	1.07	1.35	385	490
RB	1.35	1.68	490	610
RC	1.68	2.13	610	770

Tolerance on each Luminous bin is +/- 10%, and Luminous Intensity(mcd) is for reference.

Luminous II	ntensity C	Color : <u>Green</u>	@ 15mA	
Bin Code	Luminous Flux (lm)		Luminous Intensity (mcd)	
Bill Code	Min.	Max.	Min.	Max.
GA	2.70	3.36	970	1210
GB	3.36	4.25	1210	1530
GC	4.25	5.35	1530	1930

Tolerance on each Luminous bin is +/- 10%, and Luminous Intensity(mcd) is for reference.

Luminous I	Intensity	Color : <u>Blue</u>	@ 15mA	
Bin Code	Luminous Flux (lm)		Luminous Intensity (mcd)	
Bill Code	Min.	Max.	Min.	Max.
ВА	0.47	0.59	170	215
ВВ	0.59	0.75	215	270
вс	0.75	0.94	270	340

Tolerance on each Luminous bin is +/- 10%, and Luminous Intensity(mcd) is for reference.



■ WD Rank

Dominant Wavel	ength Color : <u>Red</u> , Un	it: nm @ 15mA
Bin Code	Min.	Max.
R1	619	622
R2	622	625
R3	625	628

Tolerance for each Dominate Wavelength bin is +/- 1nm.

Dominant Wavele	ength Color : <u>Green</u> , U	nit: nm @ 15mA
Bin Code	Min.	Max.
G1	522	525
G2	525	528
G3	528	531

Tolerance for each Dominate Wavelength bin is +/- 1nm.

Dominant Wavel	ength Color : <u>Blue</u> , Ur	nit: nm @ 15mA
Bin Code	Min.	Max.
B1	459	462
B2	462	465
В3	465	468

Tolerance for each Dominate Wavelength bin is +/- 1nm.



■ Bin Code on Tag Cross Table

Luminous Intensity Unit : mcd @ 15mA						
Bin Code	R	ed	Green		:	Blue
On Tag	Code	Range	Code	Range	Code	Range
A1					ВА	0.47-0.59
A2			GA	2.70-3.36	BB	0.59-0.75
А3					ВС	0.75-0.94
A4					ВА	0.47-0.59
A5	RA	1.07-1.35	GB	3.36-4.25	BB	0.59-0.75
A6					ВС	0.75-0.94
A7					BA	0.47-0.59
A8			GC	4.25-5.35	BB	0.59-0.75
A9					ВС	0.75-0.94
B1					BA	0.47-0.59
B2			GA	2.70-3.36	BB	0.59-0.75
В3				BC	ВС	0.75-0.94
B4					BA	0.47-0.59
B5	RB	1.35-1.68	GB		BB	0.59-0.75
B6					ВС	0.75-0.94
B7					BA	0.47-0.59
B8			GC	4.25-5.35	BB	0.59-0.75
B9					ВС	0.75-0.94
C1					ВА	0.47-0.59
C2			GA	2.70-3.36	BB	0.59-0.75
C3					ВС	0.75-0.94
C4					ВА	0.47-0.59
C5	RC	1.68-2.13	GB	3.36-4.25	BB	0.59-0.75
C6					ВС	0.75-0.94
C7					ВА	0.47-0.59
C8			GC	4.25-5.35	BB	0.59-0.75
C9					ВС	0.75-0.94

Tolerance on each Intensity bin is +/-10%



■ Bin Code on Tag Cross Table

	Dominant Wavelength Unit : nm @ 15mA					
Bin Code	R	ed	Gr	een	ВІ	ue
On Tag	Code	Range	Code	Range	Code	Range
D1					B1	459-462
D2			G1	522-525	B2	462-465
D3					В3	465-468
D4					B1	459-462
D5	R1	619-622	G2	525-528	B2	462-465
D6					B3	465-468
D7					B1	459-462
D8			G3	528-531	B2	462-465
D9					В3	465-468
E1					B1	459-462
E2			G1	522-525	B2	462-465
E3			B3		В3	465-468
E4					B1	459-462
E5	R2	622-625	G2	525-528	B2	462-465
E6					B3	465-468
E7					B1	459-462
E8			G3	528-531	B2	462-465
E9					B3	465-468
F1					B1	459-462
F2			G1	522-525	B2	462-465
F3					В3	465-468
F4					B1	459-462
F5	R3	625-628	G2	525-528	B2	462-465
F6					В3	465-468
F7					B1	459-462
F8			G3	528-531	B2	462-465
F9					В3	465-468

Tolerance for each Dominate Wavelength bin is +/- 1nm.



5. Typical Electrical / Optical Characteristics Curves.

(25°C Ambient Temperature Unless Otherwise Noted)

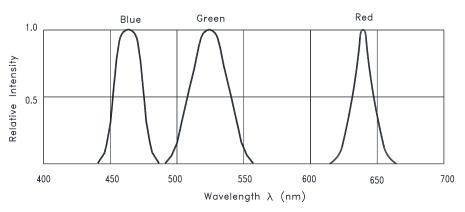


Fig.1 RELATIVE INTENSITY VS. WAVELENGTH

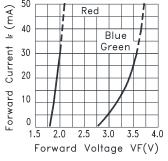


Fig.2 FORWARD CURRENT VS. FORWARD VOLTAGE

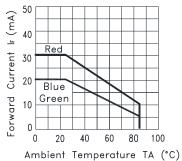


Fig.3 FORWARD CURRENT

DERATING CURVE

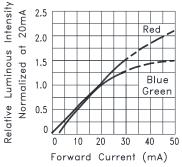


Fig.4 RELATIVE LUMINOUS INTENSITY VS. FORWARD CURRENT

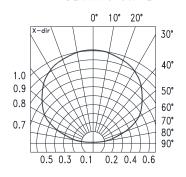


Fig.5 Spatial Distribution

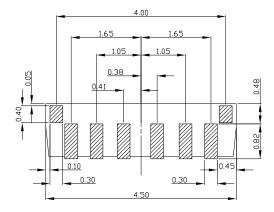


6. User Guide

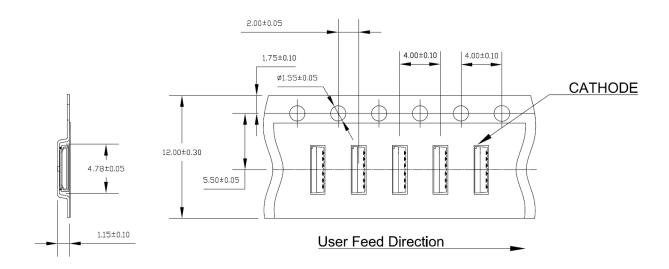
6.1 Cleaning

Do not use unspecified chemical liquid to clean LED they could harm the package. If cleaning is necessary, immerse the LED in ethyl alcohol or isopropyl alcohol at normal temperature for less one minute.

6.2 Recommend Printed Circuit Board Attachment Pad



6.3 Package Dimensions of Tape and Reel

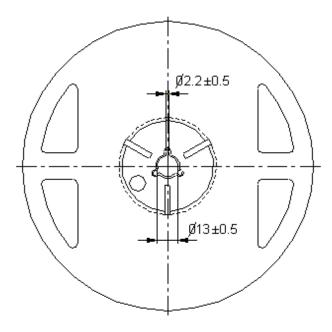


Note:

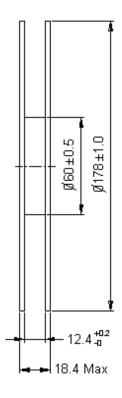
1. All dimensions are in millimeters (inches).



6.4 Package Dimensions of Reel



Note: 01. The tolerance unless mentioned is ±0.1mm 02. The measured unit is "mm"



Notes:

- 1. Empty component pockets sealed with top cover tape.
- 2. 7 inch reel 3000 pieces per reel.
- 3. Minimum packing quantity is 500 pieces for remainders.
- 4. The maximum number of consecutive missing lamps is two.
- 5. In accordance with ANSI/EIA 481 specifications.



7. Cautions

7.1 Application

The LEDs described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household applications). Consult Liteon's Sales in advance for information on applications in which exceptional reliability is required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health (such as in aviation, transportation, traffic control equipment, medical and life support systems and safety devices).

7.2 Storage

The package is sealed:

The LEDs should be stored at 30°C or less and 70%RH or less. And the LEDs are limited to use within one year, while the LEDs is packed in moisture-proof package with the desiccants inside.

The package is opened:

The storage ambient for the LEDs should not exceed 30°C temperature and 60% relative humidity.

It is recommended that LEDs out of their original packaging are IR-reflowed within 168hrs.

For extended storage out of their original packaging, it is recommended that the LEDs be stored in a sealed container with appropriate desiccant, or in a desiccators with nitrogen ambient.

LEDs stored out of their original packaging for more than 168hrs should be baked at about 60 °C for at least 48 hours before solder assembly.

7.3 Cleaning

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED if necessary.

7.4 Soldering

Recommended soldering conditions:

Ref	ow soldering	Soldering iron		
Pre-heat	150~200°C	Temperature	300°C Max.	
Pre-heat time	120 sec. Max.	Soldering time	3 sec. Max.	
Peak temperature	260°C Max.		(one time only)	
Soldering time	10 sec. Max.(Max. two times)			

Notes:

Because different board designs use different number and types of devices, solder pastes, reflow ovens, and circuit boards, no single temperature profile works for all possible combinations.

However, you can successfully mount your packages to the PCB by following the proper guidelines and PCB-specific characterization

LITE-ON Runs both component-level verification using in-house **KYRAMX98** reflow chambers and board-level assembly. The results of this testing are verified through post-reflow reliability testing. Profiles used at LITE-ON are based on JEDEC standards to ensure that all packages can be successfully and reliably surface mounted.

Figure on page3 shows a sample temperature profile compliant to JEDEC standards. You can use this example as a generic target to set up your reflow process. You should adhere to the JEDEC profile limits as well as specifications and recommendations from the solder paste manufacturer to avoid damaging the device and create a reliable solder joint.

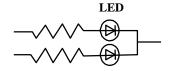


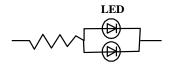
7.5 Drive Method

A LED is a current-operated device. In order to ensure intensity uniformity on multiple LEDs connected in parallel in an application, it is recommended that a current limiting resistor be incorporated in the drive circuit, in series with each LED as shown in Circuit A below.

Circuit model A

Circuit model B





- (A) Recommended circuit.
- (B) The brightness of each LED might appear different due to the differences in the I-V characteristics of those LEDs.

7.6 ESD (Electrostatic Discharge)

Static Electricity or power surge will damage the LED. Suggestions to prevent ESD damage:

- Use of a conductive wrist band or anti-electrostatic glove when handling these LEDs.
- All devices, equipment, and machinery must be properly grounded.
- Work tables, storage racks, etc. should be properly grounded.
- Use ion blower to neutralize the static charge which might have built up on surface of the LED's plastic lens as a result of friction between LEDs during storage and handling.

ESD-damaged LEDs will exhibit abnormal characteristics such as high reverse leakage current, low forward voltage, or "no lightup" at low currents.

To verify for ESD damage, check for "lightup" and Vf of the suspect LEDs at low currents.

The Vf of "good" LEDs should be >2.0V@0.1mA for InGaN product and >1.4V@0.1mA for AllnGaP product.

8. Others

The appearance and specifications of the product may be modified for improvement without prior notice.



9. Suggested Checking List

Training and Certification

- 1. Everyone working in a static-safe area is ESD-certified?
- 2. Training records kept and re-certification dates monitored?

Static-Safe Workstation & Work Areas

- 1. Static-safe workstation or work-areas have ESD signs?
- 2. All surfaces and objects at all static-safe workstation and within 1 ft measure less than 100V?
- 3. All ionizer activated, positioned towards the units?
- 4. Each work surface mats grounding is good?

Personnel Grounding

- 1. Every person (including visitors) handling ESD sensitive (ESDS) items wears wrist strap, heel strap or conductive shoes with conductive flooring?
- 2. If conductive footwear used, conductive flooring also present where operator stand or walk?
- 3. Garments, hairs or anything closer than 1 ft to ESD items measure less than 100V*?
- 4. Every wrist strap or heel strap/conductive shoes checked daily and result recorded for all DLs?
- 5. All wrist strap or heel strap checkers calibration up to date?

Note: *50V for InGaN LED.

Device Handling

- 1. Every ESDS items identified by EIA-471 labels on item or packaging?
- 2. All ESDS items completely inside properly closed static-shielding containers when not at static-safe workstation?
- 3. No static charge generators (e.g. plastics) inside shielding containers with ESDS items?
- 4. All flexible conductive and dissipative package materials inspected before reuse or recycles?

Others

- 1. Audit result reported to entity ESD control coordinator?
- Corrective action from previous audits completed?
- 3. Are audit records complete and on file?